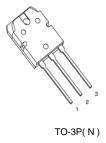
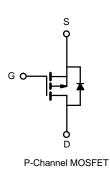


P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
- 60	0.0160 at V _{GS} = - 10 V	- 53	38 nC	
	0.0200 at V _{GS} = - 4.5 V	- 42	30110	





- 55 to 150

FEATURES

APPLICATIONS

· Load Switch

• Trench Power MOSFET • 100 % UIS Tested

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 60	V		
Gate-Source Voltage		V _{GS}	± 25	V	
	T _C = 25 °C		- 53 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		- 46.8		
Continuous Diain Current $(1_j = 150^{\circ} C)$	T _A = 25 °C	I _D	-9.2 ^b	A	
	T _A = 70 °C		- 8.1 ^b		
Pulsed Drain Current		I _{DM}	- 200		
Avalanche Current Pulse		I _{AS}	- 45		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	101	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	1	69 ^a	A	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^b		
	T _C = 25 °C		104.2 ^a	- W	
Maximum Power Dissipation	T _C = 70 °C	P	66.7 ^a		
	T _A = 25 °C	P _D	3.1 ^b		
	T _A = 70 °C		2 ^b		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State R _{thJA} 33		33	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	0,00	

T_J, T_{stg}

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

Operating Junction and Storage Temperature Range



°C

VBW2625

SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless othe	erwise noted)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	·						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		68		m)//%C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		- 5.2		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
Drain-Source On-State Resistance ^a	_	V _{GS} = - 10 V, I _D = - 30 A		0.0160			
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.0200		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b						1	
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		390			
Reverse Transfer Capacitance	C _{rss}			290			
Tatal Cata Charma	Q _g Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -55$ A		76	115	nC	
Total Gate Charge		V _{DS} = - 30 V, V _{GS} = - 4.5 V, I _D = - 55 A		38	60		
Gate-Source Charge				16			
Gate-Drain Charge	Q _{gd}			19			
Gate Resistance	Rg	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	tr	$V_{DD} = -2 V, R_{L} = 2 \Omega$		7	15		
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ I _D \cong - 10 A, V _{GEN} = - 10 V, R _g = 1 Ω		70	110	ns	
Fall Time	t _f			40	60	1	
Drain-Source Body Diode Characteristic	s					1	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 69	A	
Pulse Diode Forward Current ^a	I _{SM}				- 150		
Body Diode Voltage	V _{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			59	120	nC	
Reverse Recovery Fall Time	ta	I _F = - 50 A, di/dt = 100 A/μs, T _J = 25 °C		29		ns	
Reverse Recovery Rise Time	t _b			16			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

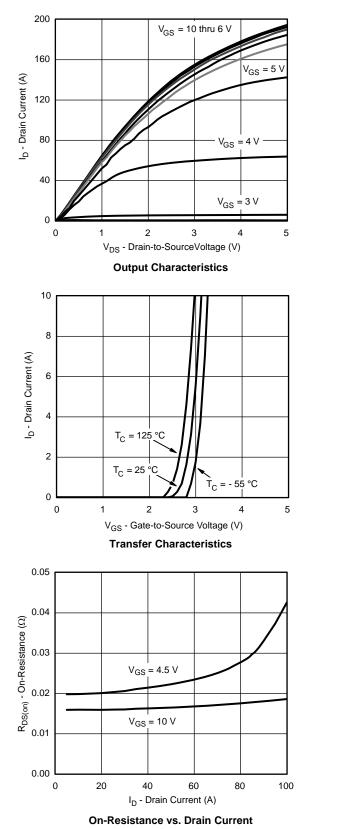
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

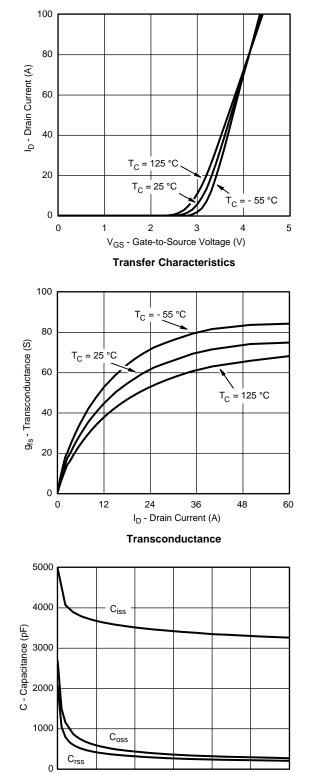
semi

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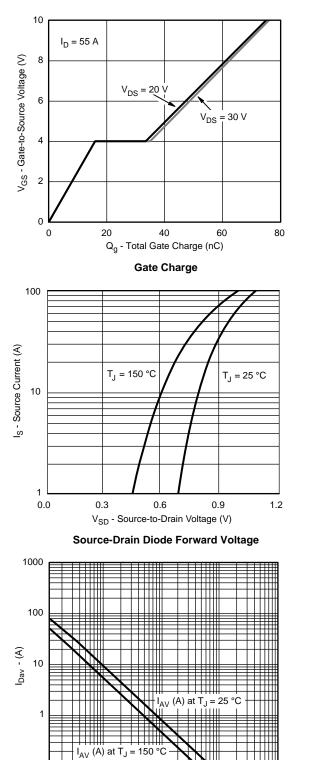


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



V_{DS} - Drain-to-Source Voltage (V) Capacitance





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{\text{in}} \text{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

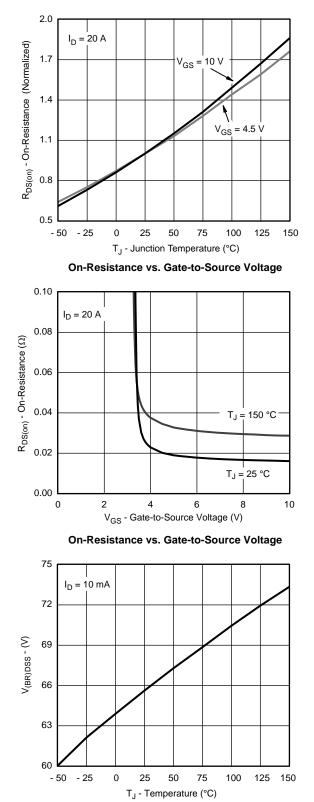
0.01

0.1

1

11111

0.001

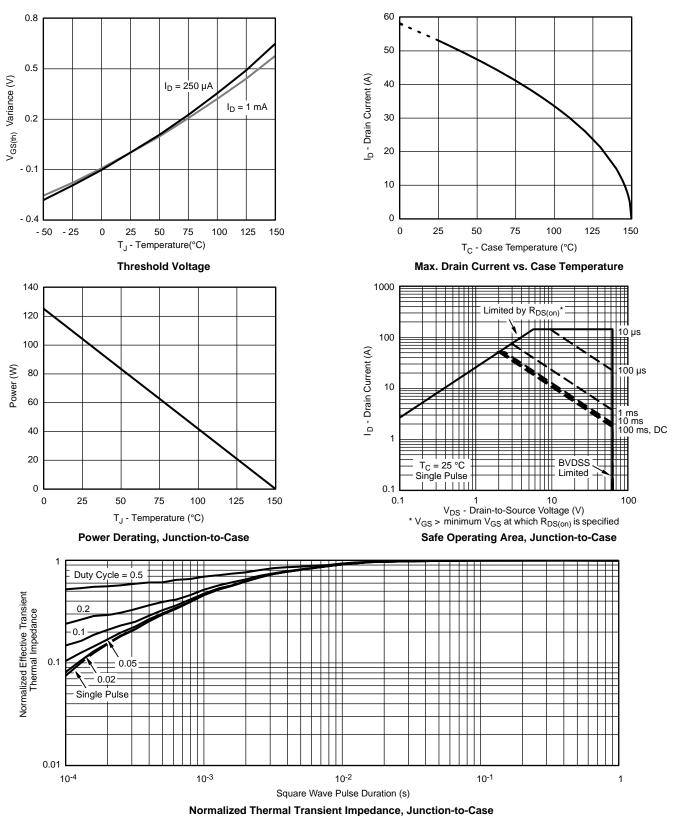


Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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